

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Kabushiki Kaisha Act One	01/31/2008
RECEIVING PARTY DATA	
Name:	Mold Research Institute Co., Ltd.
Street Address:	4-14 Osaki 3-chome, Shinagawa-ku,
City:	Tokyo
State/Country:	JAPAN
Postal Code:	141-0032
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	6832857
CORRESPONDENCE DATA	
Fax Number:	(033)556-1871
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	81-3-3556-1861
Email:	foreign@oshpat.gr.jp
Correspondent Name:	OSHIMA & NARUSHIMA
Address Line 1:	IP Building 2-20 Kanda-Jimbocho Chiyoda-
Address Line 4:	Tokyo, JAPAN 101-0051
ATTORNEY DOCKET NUMBER:	F787US
NAME OF SUBMITTER:	Yoichi Oshima
Total Attachments: 1 source=F787US#page1.tif	

OP \$40.00 6832857

**ASSIGNMENT OF UNITED STATES PATENT**

WHEREAS, KABUSHIKI KAISHA ACT ONE, a corporation of Japan, 1-10 Omori Kita 1-chome, Ota-ku, Tokyo, Japan (formerly of 48-3 Nishikamata 7-chome, Ota-ku, Tokyo, Japan), is the owner of a right, title, and interest in and to United States Patent 6,832,857, "PLASTIC OPTICAL FIBER FERRULE", issued December 21, 2004, by reason of an assignment recorded in the United States Patent and Trademark Office at Reel 012586, Frame 0945;

AND, WHEREAS, MOLD RESEARCH INSTITUTE CO., LTD., a corporation of Japan, 4-14 Osaki 3-chome, Shinagawa-ku, Tokyo, Japan (formerly of 7-7, Minamiooi 6-chome, Shinagawa-ku Tokyo, Japan), is desirous of acquiring the entire right, title, and interest of said KABUSHIKI KAISHA ACT ONE in the said United States Patent;

NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, said KABUSHIKI KAISHA ACT ONE, by these presents does sell, assign and transfer unto said MOLD RESEARCH INSTITUTE CO., LTD. its entire right, title, and interest in and to the said United States Patent, together with any extension, reissue, or reexamination thereof, the same to be held and enjoyed by said MOLD RESEARCH INSTITUTE CO., LTD. for its own use and behoof, and for its successors and assigns, to the full end of the term for which said Patent is granted, as fully and entirely as the same would have been held by said KABUSHIKI KAISHA ACT ONE had this assignment and sale not been made.

AND said KABUSHIKI KAISHA ACT ONE does further grant to said MOLD RESEARCH INSTITUTE CO., LTD. its successors and assigns, the right to any and all claims for infringement of the said United States Patent.

Date: January 31, 2008



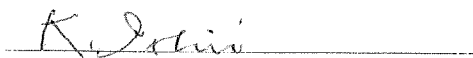
Signature of the assignor:

Kabushiki Kaisha Act One

Name of the signatory: Naoto Osada

Title of the signatory: President

Date: January 31, 2008



Signature of the assignee:

Mold Research Institute Co., Ltd.

Name of the signatory: Kiyoshi Ishii

Title of the signatory: President

**PATENT**

**RECORDED: 02/04/2008**

**REEL: 020497 FRAME: 0687**